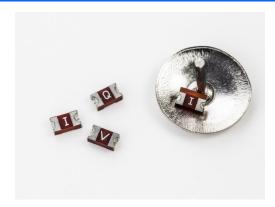








AirMatrix[®] Surface Mount Fuses AF Series, 1206 Size



Application Fields:

- Notebook, Ultrabook
- Backlight Driver
- DC/DC Converter
- Low voltage lighting power
- Automotive electronics

Clearing Time Characteristics:

| % of Current Rating | Clearing Time at 25°C | | |
|---------------------|-----------------------|-----------|--|
| N of Current Rating | Min. | Max. | |
| 100% | 4 hour | | |
| 250% | | 5 seconds | |

Agency Approval:

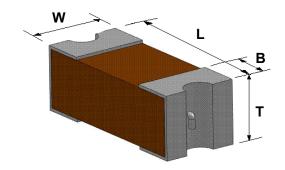
Recognized Under the Components Program of Underwriters Laboratories. File Number: E232989

Features:

- Fast acting at 250% overload current level
- Excellent inrush current withstanding capability
- Extremely thin body for space saving
- Much safer with wire-in-air design
- Fiberglass enforced epoxy fuse body
- · Copper termination with nickel and tin plating
- Operating temperature range: -55°C to +125 °C (with derating)
- 100% lead-free

Shape and Dimensions:

| Unit | Inch | mm |
|------|------------------------|---------------------|
| L | 0.126 ± 0.008 | 3.20 ± 0.20 |
| w | 0.063 + 0.012 / -0.004 | 1.60 + 0.30 / -0.20 |
| Т | 0.042 ± 0.006 | 1.08 ± 0.15 |
| В | 0.033 ± 0.012 | 0.85 ± 0.30 |









AirMatrix[®] Surface Mount Fuses AF Series, 1206 Size

Ordering Information:

| Part Number | Current Rating (A) | Marking (White) | Voltage Rating (VDC) | Interrupting Rating | Nominal DCR (Ω) | Nominal I ² t (A ² s) | |
|---------------|-----------------------|----------------------|-------------------------|------------------------|-----------------|--|--------|
| AF1206F1.50TM | 1.50 | G | | | 0.050 | 0.37 | |
| AF1206F1.60TM | 1.60 | Т | | | 0.043 | 0.52 | |
| AF1206F2.00TM | 2.00 | ı | | | 0.032 | 0.88 | |
| AF1206F2.50TM | 2.50 | J | 65 | 504@65VD0 | 0.028 | 1.1 | |
| AF1206F3.00TM | 3.00 | K | 05 | 50A@65VDC | 0.022 | 1.9 | |
| AF1206F3.15TM | 3.15 | V | | | | 0.020 | 2.2 |
| AF1206F3.50TM | 3.50 | L | | | | 0.018 | 2.6 |
| AF1206F4.00TM | 4.00 | М | | | 0.016 | 3.3 | |
| AF1206F5.00TM | 5.00 | N | | | 0.013 | 5.4 | |
| AF1206F6.30TM | 6.30 | 0 | 32 | | | 0.010 | 8.9 |
| AF1206F7.00TM | 7.00 | Р | | | 0.0092 | 10.4 | |
| AF1206F8.00TM | 8.00 | R | | 32 | 50A@32VDC | 0.0084 | 13.5 |
| AF1206F10.0TM | 10.0 | Q | | | | 0.0050 | 11.2 |
| AF1206F12.0TM | 12.0 | Х | | | | | 0.0041 |
| AF1206F15.0TM | 15.0 | Υ | | | 0.0035 | 24.5 | |

^{1.} Resistance is measured at \leq 10% of rated current and 25 $^{\circ}$ C ambient.

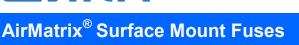
^{2.} Melting I²t is calculated at 0.001 second pre-arcing time.



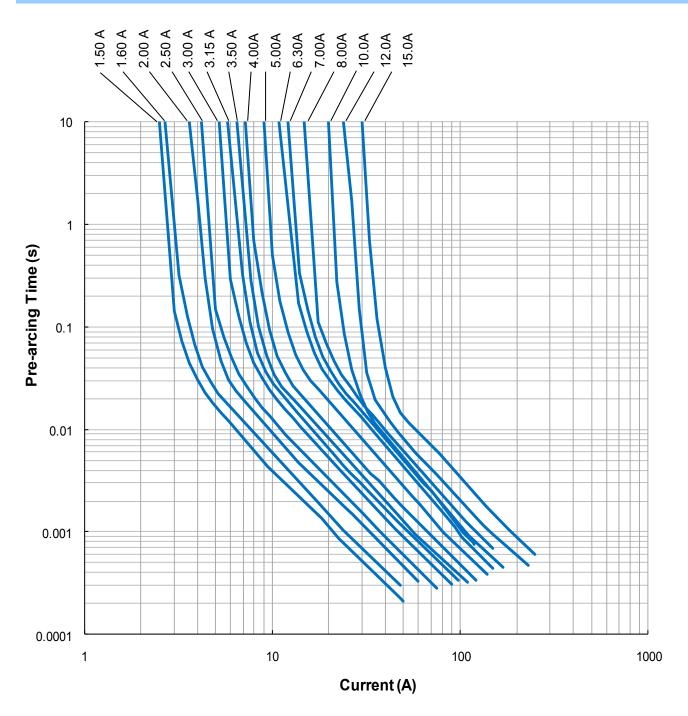
AF Series, 1206 Size







Average Pre-arcing Time Curves:





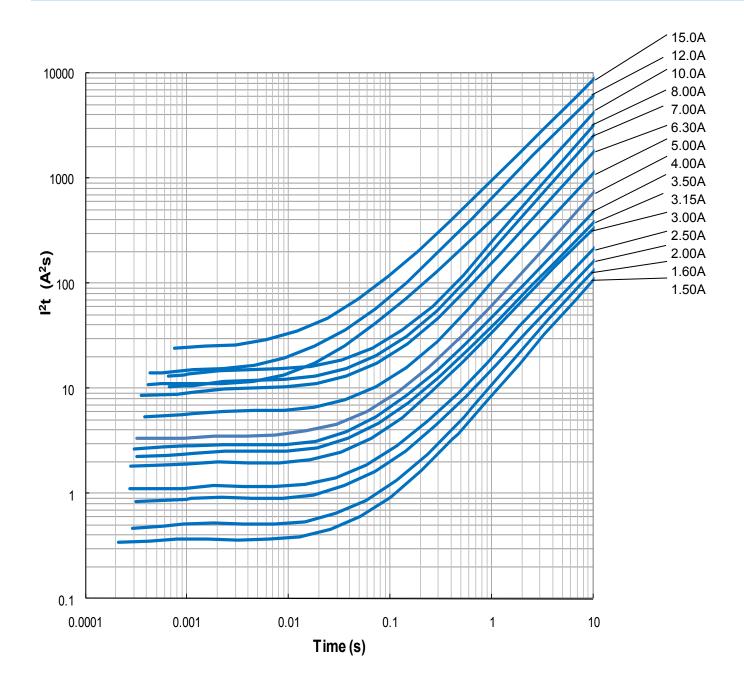






AirMatrix® Surface Mount Fuses AF Series, 1206 Size

Average I²t vs. t Curves:











AirMatrix® Surface Mount Fuses

Product Identification:

AF2 1.00 V125 T M

(1) (2) (3) (4) (5)

(1) Series Code: AF2

(2) Current Rating Code: 1.00—1.00A
(3) Voltage Rating Code: V125—125VDC
(4) Package Code: T - Tape & Reel, B - Bulk

(5) Marking Code: M - With Marking

AF 1206 F 2.00 T M

(1) (2) (3) (4) (5) (6)

(1) Series Code: AF—AF Series, MF—MF Series

(2) Size Code: Standard EIA Chip Sizes(3) Time/Current Characteristic: F

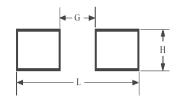
(4) Current Rating: 2.00—2.00A

(5) Package Code: T - Tape & Reel, B - Bulk

(6) Marking Code: M - With Marking

Recommended Land Pattern:

| | Al | F2 | AF1206 | | MF2410 | | MF1210 | |
|---|-------|------|--------|------|--------|------|--------|------|
| | Inch | mm | Inch | mm | Inch | mm | Inch | mm |
| L | 0.338 | 8.60 | 0.173 | 4.40 | 0.338 | 8.60 | 0.170 | 4.40 |
| G | 0.118 | 3.00 | 0.059 | 1.50 | 0.118 | 3.00 | 0.070 | 1.70 |
| Н | 0.124 | 3.15 | 0.071 | 1.80 | 0.110 | 2.80 | 0.110 | 2.70 |



Packaging:

| Chip Size | Parts on 7 inch (178 mm) Reel | | |
|-------------|-------------------------------|--|--|
| 2410 (6125) | 2,000 | | |
| 1210 (3225) | 2,500 | | |
| 1206 (3216) | 3,500 | | |

Storage:

The maximum ambient temperature shall not exceed 35° C . Storage temperatures higher than 35° C could result in the deformation of packaging materials.

The maximum relative humidity recommended for storage is 75%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.

Sealed vacuum foil bags with desiccant should only be opened prior to use.







AirMatrix® Surface Mount Fuses

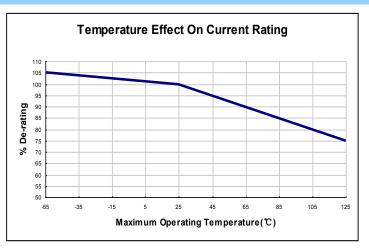
Fuse Selection and Temperature De-rating Guideline:

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be "derated".

To select a fuse from the catalog, the following rule may be followed:

Catalog Fuse Current Rating = Nominal Operating Current / 0.75 / % De-rating at the maximum operating temperature.

Example: At maximum operating temperature of 65°C, % De-rating is 90%. The nominal operating current is 4 A. The current rating for fuse selected from the catalog shall be:



Environmental Tests:

| Reliability Test | Test Condition and Requirement | Test Reference | |
|---------------------------|---|--------------------------------|--|
| Reflow & Bend | 3 reflows at 245°C followed by a 2 mm bend, 20% DCR change max. (10% for ≤ 1 A), no mechanical damage | Refer to AEM QIQ034 ,QIQ048 | |
| Solderability | 245°C, 5 seconds, new solder coverage 90% minimum | MIL-STD-202 Method 208 | |
| Soldering Heat Resistance | 260°C, 10 seconds, 20% DCR change max. (10% for ≤ 1 A), new solder coverage 75% minimum | MIL-STD-202 Method 210 | |
| Life | 25°C, 2000 hours, 80% rated current (75% for < 1 A), voltage drop change≤ ±20% | Refer to AEM QIQ106 | |
| Thermal Shock | -65°C to +125°C, 100 cycles, 10% DCR change max., no mechanical damage | MIL-STD-202 Method 107 | |
| Mechanical Vibration | 5 – 3000 Hz, 0.4 inch double amplitude or 30 G peak, 10% DCR change max., no mechanical damage | MIL-STD-202 Method 204 | |
| Mechanical Shock | 1500 G, 0.5 milliseconds, half-sine shocks, 10% DCR change max., no mechanical damage | MIL-STD-202 Method 213 | |
| Salt Spray | 5% salt solution, 48 hour exposure, 10% DCR change max., no excessive corrosion | MIL-STD-202 Method 101 | |
| Moisture Resistance | 10 cycles, 15% DCR change max., no excessive corrosion | MIL-STD-202 Method 106 | |





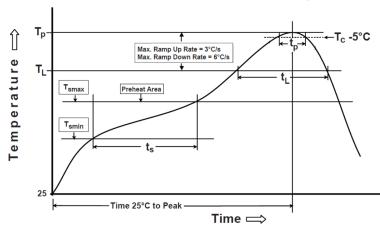




AirMatrix® Surface Mount Fuses

Soldering Temperature Profile:

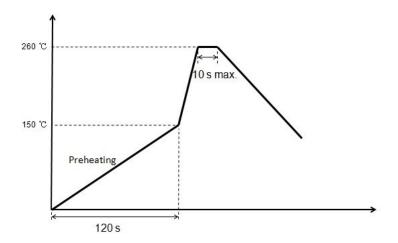
* Recommended Temperature Profile for Reflow Soldering



| | Pb-Free |
|---|-----------------|
| Profile Feature | Assembly |
| Preheat/Soak | |
| Temperature Min (T _{smin}) | 150°C |
| Temperature Max(T _{smax}) | 200°C |
| Time(t_s) from (T_{smin} to T_{smax}) | 60~120 seconds |
| Ramp-uprate (T _L to T _p) | 3°C/second |
| ramp aprate (TE to Tp) | max. |
| Liquidous temperature(T _L) | 217°C |
| Time(t _L) maintained above T _L | 60~150 seconds |
| Peak package body temperature (T _p) | 260°C |
| Time (t _p)*within 5°C of the specified classification temperature (T _c) | 30 seconds * |
| Ramp-down rate (T _p to T _L) | 6°C/second max. |
| Time 25°C to peak temperature | 8 minutes max. |

 $^{^{\}star}$ Tolerance for peak profile temperature (T_{p}) is defined as a supplier minimum and a user maximum

* Recommended Temperature Profile for Wave Soldering







Disclaimer

Specifications are subject to change without notice. AEM products are designed for specific applications and should not be used for any purpose (including, without limitation, automotive, aerospace, medical, life-saving applications, or any other application which requires especially high reliability for the prevention of such defect as may directly cause damage to the third party's life, body or property) not expressly set forth in applicable AEM product documentation. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Warranties granted by AEM shall be deemed void for products used for any purpose not expressly set forth in applicable AEM product documentation. AEM shall not be liable for any claims or damages arising out of products used in applications not expressly intended by AEM as set forth in applicable AEM product documentation. The sale and use of AEM products is subject to AEM terms and conditions of sale. Please refer